

May 2015

# MBR3035PT - MBR3060PT 30 A Schottky Barrier Rectifiers

## **Features**

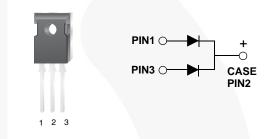
- · Low Power Loss, High Efficiency
- High Surge Capacity
- Metal Silicon Junction, Majority Carrier Conduction
- High Current Capacity, Low Forward Voltage Drop
- · Guard Ring for Over-Voltage Protection (OVP)

## **Applications**

- · Low-Voltage
- High-Frequency Inverters
- · Free Wheeling
- Polarity Protection

## **Description**

This center-tap Schottky rectifier is optimal for secondary rectification and free-wheeling applications for high-efficiency DC-DC convertor design, which features very low forward voltage drop and low leakage current.



TO-3P/TO-247AD

## **Ordering Information**

Part Number	Marking	Package	Packing Method
MBR3035PT	MBR3035PT		
MBR3045PT	MBR3045PT	TO-247 3L	Rail
MBR3050PT	MBR3050PT	10-247 SL	Naii
MBR3060PT	MBR3060PT		

## **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at  $T_A = 25^{\circ}$ C unless otherwise noted.

			Value			
Symbol	Parameter	MBR 3035PT	MBR 3045PT	MBR 3050PT	MBR 3060PT	Unit
V <sub>RRM</sub>	Maximum Repetitive Reverse Voltage	35	45	50	60	V
I <sub>F(AV)</sub>	Average Rectified Forward Current .375-inch Lead Length		30			
I <sub>FSM</sub>	Non-Repetitive Peak Forward Surge Current: 8.3 ms Single Half-Sine Wave		200			Α
T <sub>STG</sub>	Storage Temperature Range		-65 to +175			°C
TJ	Operating Junction Temperature Range		-65 to +150			°C

## **Thermal Characteristics**

Values are at  $T_A = 25^{\circ}C$  unless otherwise noted.

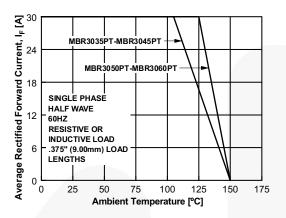
Symbol	Parameter	Value	Unit
$P_{D}$	Power Dissipation	3.0	W
$R_{\theta JC}$	Thermal Resistance, Junction to Case	1.4	°C/W

## **Electrical Characteristics**

Values are at  $T_A = 25$ °C unless otherwise noted.

	Symbol Parameter		Value					
Symbol			MBR 3035PT	MBR 3045PT	MBR 3050PT	MBR 3060PT	Unit	
V <sub>F</sub> Maximum Forward per Leg		$I_F = 20 \text{ A}, T_C = 25^{\circ}\text{C}$			0.75		V	
	Maximum Forward Voltage,	$I_F = 20 \text{ A}, T_C = 125^{\circ}\text{C}$	0.60		0.65			
	per Leg	I <sub>F</sub> = 30 A, T <sub>C</sub> = 25°C	0.76					
		$I_F = 30 \text{ A}, T_C = 125^{\circ}\text{C}$	0.	72				
I_	Maximum Reverse Current	T <sub>A</sub> = 25°C	0.1		5.0		mA	
I <sub>R</sub>	at Rated V <sub>RRM</sub> , per Leg	T <sub>A</sub> = 125°C	60.0		10	0.0		
I <sub>RRM</sub>	Peak Repetitive Reverse Surge Current, per Leg 2.0 µs Pulse Width, f = 1.0 kHz		1	.0	0	.5	А	

## **Typical Performance Characteristics**



**Figure 1. Forward Current Derating Curve** 

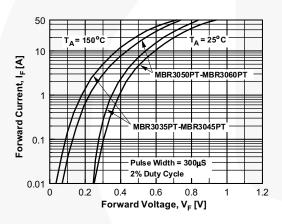


Figure 3. Forward Voltage Characteristics

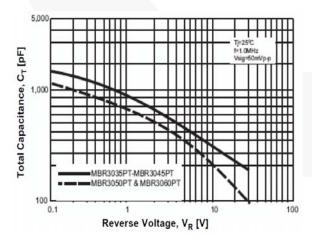


Figure 5. Total Capacitance

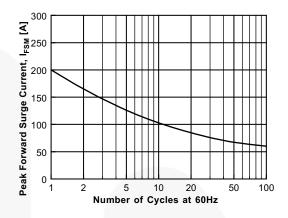


Figure 2. Non-Repetitive Surge Current

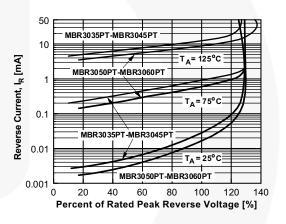


Figure 4. Reverse Current vs. Reverse Voltage

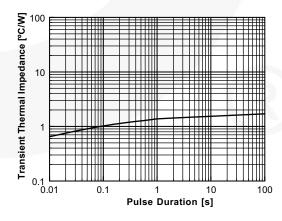
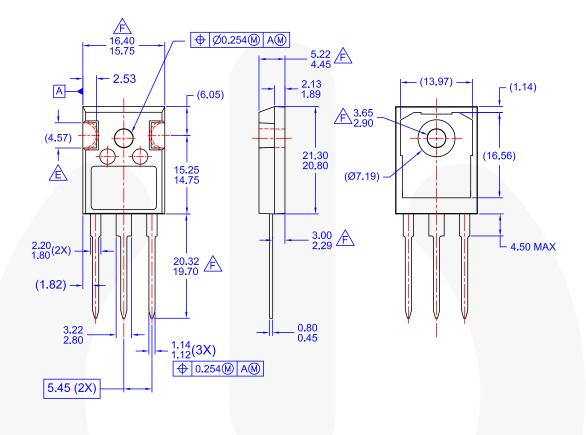


Figure 6. Thermal Impedance Characteristics

# **Physical Dimensions**



**NOTES: UNLESS OTHERWISE SPECIFIED** 

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- B. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- C. ALL DIMENSIONS ARE IN MILLIMETERS.
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A DOES NOT COMPLY JEDEC STANDARD VALUE.

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Figure 7. TO-247, MOLDED, 3 LEADS, JEDEC OPTION AD





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Definition of Terms					
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